

SN74AUP1T08 Low Power, 1.8, 2.5, 3.3-V Input, 3.3-V CMOS Output, Single 2-Input Positive-AND Gate

1 Features

- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)
- Single-Supply Voltage Translator
- Output Level Up to Supply V_{CC} CMOS Level
 - 1.8 V to 3.3 V (at $V_{CC} = 3.3$ V)
 - 2.5 V to 3.3 V (at $V_{CC} = 3.3$ V)
 - 1.8 V to 2.5 V (at $V_{CC} = 2.5$ V)
 - 3.3 V to 2.5 V (at $V_{CC} = 2.5$ V)
- Schmitt-Trigger Inputs Reject Input Noise and Provide Better Output Signal Integrity
- I_{off} Supports Partial Power Down ($V_{CC} = 0$ V)
- Very Low Static Power Consumption: 0.1 μ A
- Very Low Dynamic Power Consumption: 0.9 μ A
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- Pb-Free Packages Available: SC70 (DCK) 2 x 2.1 x 0.65 mm (Height 1.1 mm)
- More Gate Options Available at www.ti.com/littlelogic

2 Description

The SN74AUP1T08 performs the Boolean function $Y = A \cdot B$ or $Y = \overline{A} + \overline{B}$ with designation for logic-level translation applications with output referenced to supply V_{CC} .

AUP technology is the industry's lowest-power logic technology designed for use in extending battery-life in operating. All input levels that accept 1.8-V LVCMS signals, while operating from either a single 3.3-V or 2.5-V V_{CC} supply. This product also maintains excellent signal integrity (see [Figure 5-1](#) and [Figure 5-2](#)).

The wide V_{CC} range of 2.3 V to 3.6 V allows the possibility of switching output level to connect to external controllers or processors.

Schmitt-trigger inputs ($\Delta V_T = 210$ mV between positive and negative input transitions) offer improved noise immunity during switching transitions, which is especially useful on analog mixed-mode designs. Schmitt-trigger inputs reject input noise, ensure integrity of output signals, and allow for slow input signal transition.

I_{off} is a feature that allows for powered-down conditions ($V_{CC} = 0$ V) and is important in portable and mobile applications. When $V_{CC} = 0$ V, signals in the range from 0 V to 3.6 V can be applied to the inputs and outputs of the device. No damage occurs to the device under these conditions.

The SN74AUP1T08 is designed with optimized current-drive capability of 4 mA to reduce line reflections, overshoot, and undershoot caused by high-drive outputs.

Device Information

PART NUMBER	PACKAGE ⁽¹⁾	BODY SIZE (NOM)
SN74AUP1T08	SC70 (5)	2mm x 1.25mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.



Logic Diagram (AND Gate)



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

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3 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision * (April 2010) to Revision A (September 2020)	Page
• Added <i>Device Information</i> table, <i>Device Functional Modes</i> , <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section.....	1
• Updated the numbering format for tables, figures, and cross-references throughout the document.....	1

4 Pin Configuration and Functions

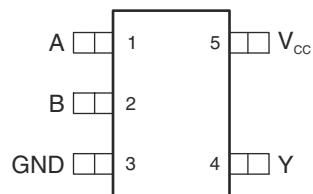


Figure 4-1. DCK Package 5-Pin SC70 Top View

5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

			MIN	MAX	UNIT
V_{CC}	Supply voltage range		-0.5	4.6	V
V_I	Input voltage range ⁽²⁾		-0.5	4.6	V
V_O	Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾		-0.5	4.6	V
V_O	Output voltage range in the high or low state ⁽²⁾		-0.5	$V_{CC} + 0.5$	V
I_{IK}	Input clamp current	$V_I < 0$		-50	mA
I_{OK}	Output clamp current	$V_O < 0$		-50	mA
I_O	Continuous output current			± 20	mA
	Continuous current through V_{CC} or GND			± 50	mA
θ_{JA}	Package thermal impedance ⁽³⁾	DCK package		259	°C/W
T_{stg}	Storage temperature		-65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The package thermal impedance is calculated in accordance with JESD 51-7.

5.2 Recommended Operating Conditions

See⁽¹⁾

			MIN	MAX	UNIT
V_{CC}	Supply voltage		2.3	3.6	V
V_I	Input voltage		0	3.6	V
V_O	Output voltage		0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 2.3$ V		-3.1	mA
		$V_{CC} = 3$ V		-4	
I_{OL}	Low-level output current	$V_{CC} = 2.3$ V		3.1	mA
		$V_{CC} = 3$ V		4	
T_A	Operating free-air temperature		-40	85	°C

- (1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. See *Implications of Slow or Floating CMOS Inputs*, SCBA004.

5.3 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C}$ to 85°C	UNIT
			MIN	TYP	MAX		
V_{T+} Positive-going input threshold voltage		2.3 V to 2.7 V	0.6	1.1	0.6	1.1	V
		3 V to 3.6 V	0.75	1.16	0.75	1.19	
V_{T-} Negative-going input threshold voltage		2.3 V to 2.7 V	0.35	0.6	0.35	0.6	V
		3 V to 3.6 V	0.5	0.85	0.5	0.85	
ΔV_T Hysteresis ($V_{T+} - V_{T-}$)		2.3 V to 2.7 V	0.23	0.6	0.1	0.6	V
		3 V to 3.6 V	0.25	0.56	0.15	0.56	
V_{OH}	$I_{OH} = -20 \mu\text{A}$	2.3 V to 3.6 V	$V_{CC} - 0.1$		$V_{CC} - 0.1$		V
	$I_{OH} = -2.3 \text{ mA}$	2.3 V	2.05		1.97		

5.3 Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			T _A = -40°C to 85°C		UNIT
			MIN	TYP	MAX	MIN	MAX	
I _{OH}	I _{OH} = -3.1 mA	3 V	1.9			1.85		V
	I _{OH} = -2.7 mA		2.72			2.67		
	I _{OH} = -4 mA		2.6			2.55		
V _{OL}	I _{OL} = 20 µA	2.3 V to 3.6 V		0.1		0.1		V
	I _{OL} = 2.3 mA	2.3 V		0.31		0.33		
	I _{OL} = 3.1 mA			0.44		0.45		
	I _{OL} = 2.7 mA	3 V		0.31		0.33		
	I _{OL} = 4 mA			0.44		0.45		
I _I	All inputs	V _I = 3.6 V or GND	0 V to 3.6 V		0.1		0.5	µA
I _{off}		V _I or V _O = 0 V to 3.6 V	0 V		0.1		0.5	µA
ΔI _{off}		V _I or V _O = 3.6 V	0 V to 0.2 V		0.2		0.5	µA
I _{CC}		V _I = 3.6 V or GND, I _O = 0	2.3 V to 3.6 V		0.5		0.9	µA
ΔI _{CC}	One input at 0.3 V or 1.1 V, Other inputs at 0 or V _{CC} , I _O = 0	2.3 V to 2.7 V				4		µA
	One input at 0.45 V or 1.2 V, Other inputs at 0 or V _{CC} , I _O = 0	3 V to 3.6 V				12		
C _i	V _I = V _{CC} or GND	3.3 V		1.5				pF
C _o	V _O = V _{CC} or GND	3.3 V		3				pF

5.4 Switching Characteristics

over recommended operating free-air temperature range, V_{CC} = 2.5 V ± 0.2 V, V_I = 1.8 V ± 0.15 V (unless otherwise noted) (see [Figure 6-1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L	T _A = 25°C			T _A = -40°C to 85°C		UNIT
				MIN	TYP	MAX	MIN	MAX	
t _{pd}	A or B	Y	5 pF	1.8	2.3	2.9	0.5	6.8	ns
			10 pF	2.3	2.8	3.4	1	7.9	
			15 pF	2.6	3.1	3.8	1	8.7	
			30 pF	3.8	4.4	5.1	1.5	10.8	

5.5 Switching Characteristics

over recommended operating free-air temperature range, $V_{CC} = 2.5 V \pm 0.2 V$, $V_I = 2.5 V \pm 0.2 V$ (unless otherwise noted) (see [Figure 6-1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C_L	$T_A = 25^\circ C$			$T_A = -40^\circ C$ to $85^\circ C$		UNIT
				MIN	TYP	MAX	MIN	MAX	
t_{pd}	A or B	Y	5 pF	1.8	2.3	3.1	0.5	6	ns
			10 pF	2.2	2.8	3.5	1	7.1	
			15 pF	2.6	3.2	5.2	1	7.9	
			30 pF	3.7	4.4	5.2	1.5	10	

5.6 Switching Characteristics

over recommended operating free-air temperature range, $V_{CC} = 2.5 V \pm 0.2 V$, $V_I = 3.3 V \pm 0.3 V$ (unless otherwise noted) (see [Figure 6-1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C_L	$T_A = 25^\circ C$			$T_A = -40^\circ C$ to $85^\circ C$		UNIT
				MIN	TYP	MAX	MIN	MAX	
t_{pd}	A or B	Y	5 pF	2	2.7	3.5	0.5	5.5	ns
			10 pF	2.4	3.1	3.9	1	6.5	
			15 pF	2.8	3.5	4.3	1	7.4	
			30 pF	4	4.7	5.5	1.5	9.5	

5.7 Switching Characteristics

over recommended operating free-air temperature range, $V_{CC} = 3.3 V \pm 0.3 V$, $V_I = 1.8 V \pm 0.15 V$ (unless otherwise noted) (see [Figure 6-1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C_L	$T_A = 25^\circ C$			$T_A = -40^\circ C$ to $85^\circ C$		UNIT
				MIN	TYP	MAX	MIN	MAX	
t_{pd}	A or B	Y	5 pF	1.6	2	2.5	0.5	8	ns
			10 pF	2	2.4	2.9	1	8.5	
			15 pF	2.3	2.8	3.3	1	9.1	
			30 pF	3.4	3.9	4.4	1.5	9.8	

5.8 Switching Characteristics

over recommended operating free-air temperature range, $V_{CC} = 3.3 V \pm 0.3 V$, $V_I = 2.5 V \pm 0.2 V$ (unless otherwise noted) (see [Figure 6-1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C_L	$T_A = 25^\circ C$			$T_A = -40^\circ C$ to $85^\circ C$		UNIT
				MIN	TYP	MAX	MIN	MAX	
t_{pd}	A or B	Y	5 pF	1.6	1.9	2.4	0.5	5.3	ns
			10 pF	2	2.3	2.7	1	6.1	
			15 pF	2.3	2.7	3.1	1	6.8	
			30 pF	3.4	3.8	4.2	1.5	8.5	

5.9 Switching Characteristics

over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$, $V_I = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 6-1)

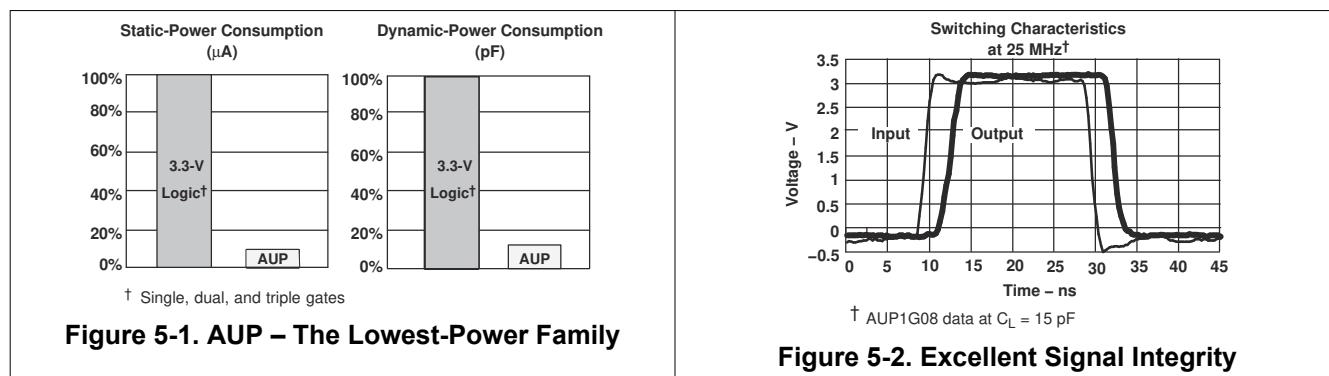
PARAMETER	FROM (INPUT)	TO (OUTPUT)	C_L	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C}$ to 85°C		UNIT
				MIN	TYP	MAX	MIN	MAX	
t_{pd}	A or B	Y	5 pF	1.6	2.1	2.7	0.5	4.7	ns
			10 pF	2	2.4	3	1	5.7	
			15 pF	2.3	2.7	3.3	1	6.2	
			30 pF	3.4	3.8	4.4	1.5	7.8	

5.10 Operating Characteristics

$T_A = 25^\circ\text{C}$

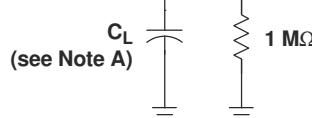
PARAMETER	TEST CONDITIONS	$V_{CC} = 2.5\text{ V}$	$V_{CC} = 3.3\text{ V}$	UNIT
		TYP	TYP	
C_{pd} Power dissipation capacitance	$f = 10\text{ MHz}$	4	5	pF

5.11 Typical Characteristics



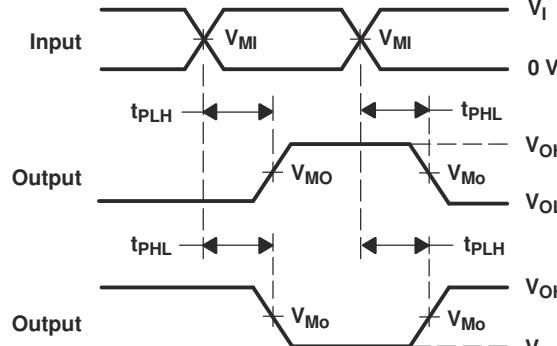
6 Parameter Measurement Information

From Output
Under Test



LOAD CIRCUIT

	$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$
C_L	5, 10, 15, 30 pF	5, 10, 15, 30 pF
V_{MI}	$V_I/2$	$V_I/2$
V_{MO}	$V_{CC}/2$	$V_{CC}/2$



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS

NOTES:

- C_L includes probe and jig capacitance.
- All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, slew rate $\geq 1 \text{ V/ns}$.
- The outputs are measured one at a time, with one transition per measurement.
- t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 6-1. Load Circuit And Voltage Waveforms

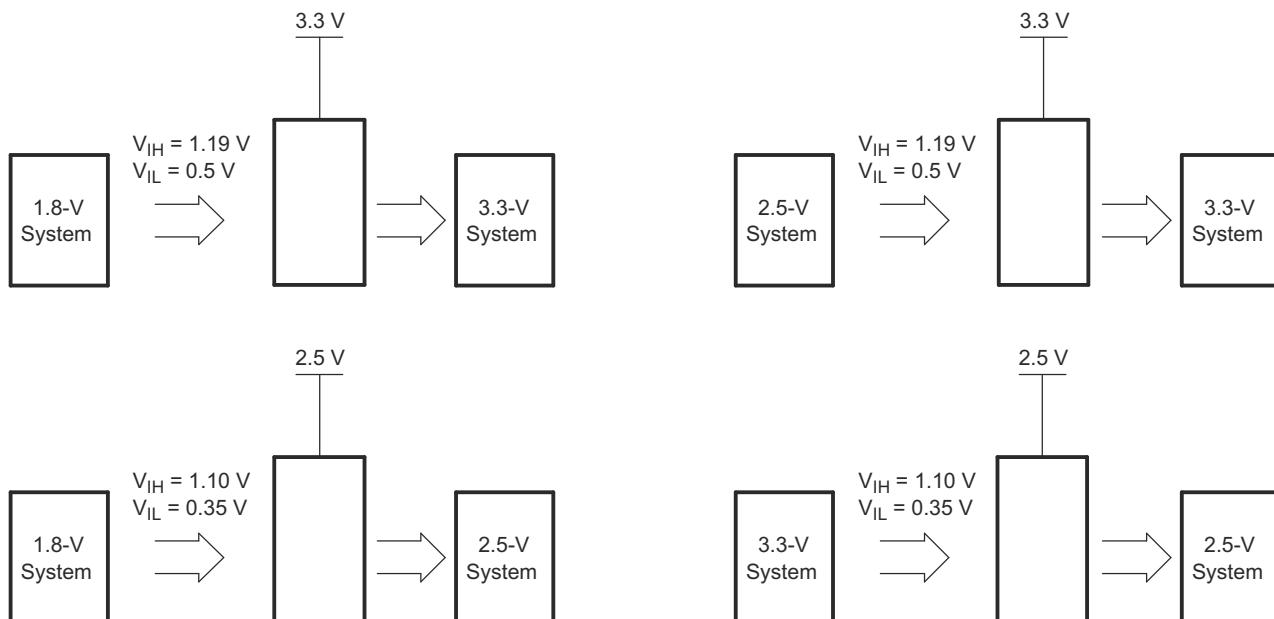


Figure 6-2. Typical Design Examples

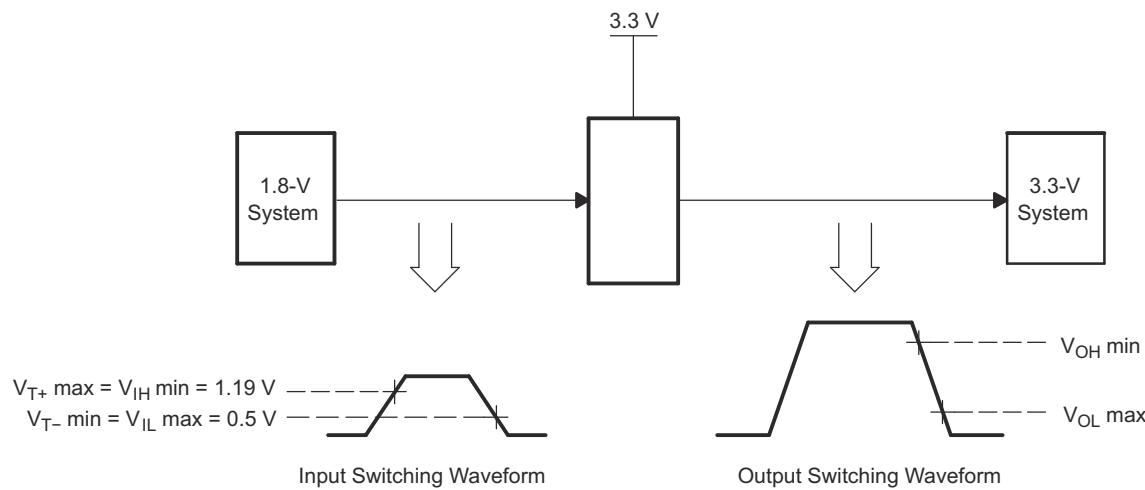


Figure 6-3. Switching Thresholds For 1.8-V To 3.3-V Translation

7 Detailed Description

7.1 Functional Block Diagram



Figure 7-1. Logic Diagram (AND Gate)

7.2 Device Functional Modes

Table 7-1 through Table 7-3 list the functional modes of the SN74AUP1T08 device.

Table 7-1. Function Table

INPUTS (Lower Level Input)		OUTPUT (V_{CC} CMOS)
A	B	Y
H	H	H
L	X	L
X	L	L

Table 7-2. Supply V_{CC} = 2.3 V To 2.7 V (2.5 V)

INPUTS V_{T+} max = V_{IH} min V_{T-} min = V_{IL} max		OUTPUT CMOS
A	B	Y
V_{IH} = 1.1 V		V_{OH} = 1.85 V
V_{IL} = 0.35 V		V_{OL} = 0.45 V

Table 7-3. Supply V_{CC} = 3 V To 3.6 V (3.3 V)

INPUTS V_{T+} max = V_{IH} min V_{T-} min = V_{IL} max		OUTPUT CMOS
A	B	Y
V_{IH} = 1.19 V		V_{OH} = 2.55 V
V_{IL} = 0.5 V		V_{OL} = 0.45 V

8 Device and Documentation Support

8.1 Documentation Support

8.1.1 Related Documentation

For related documentation see the following:

Implications of Slow or Floating CMOS Inputs, SCBA004

8.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

8.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

8.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.

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8.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

9 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74AUP1T08DCKR	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 85	6EF
SN74AUP1T08DCKR.B	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	6EF
SN74AUP1T08DCKRG4	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	6EF
SN74AUP1T08DCKRG4.B	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	6EF

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

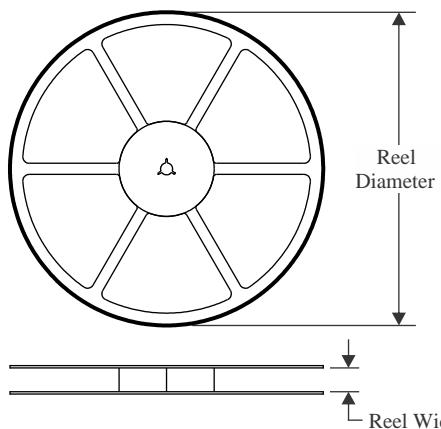
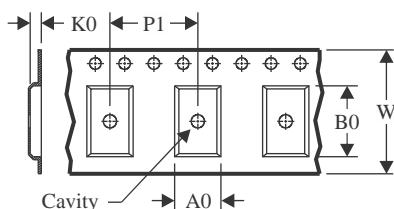
⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

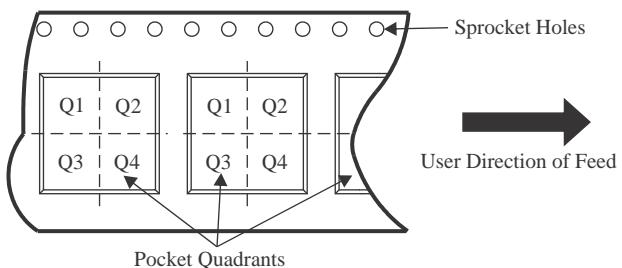
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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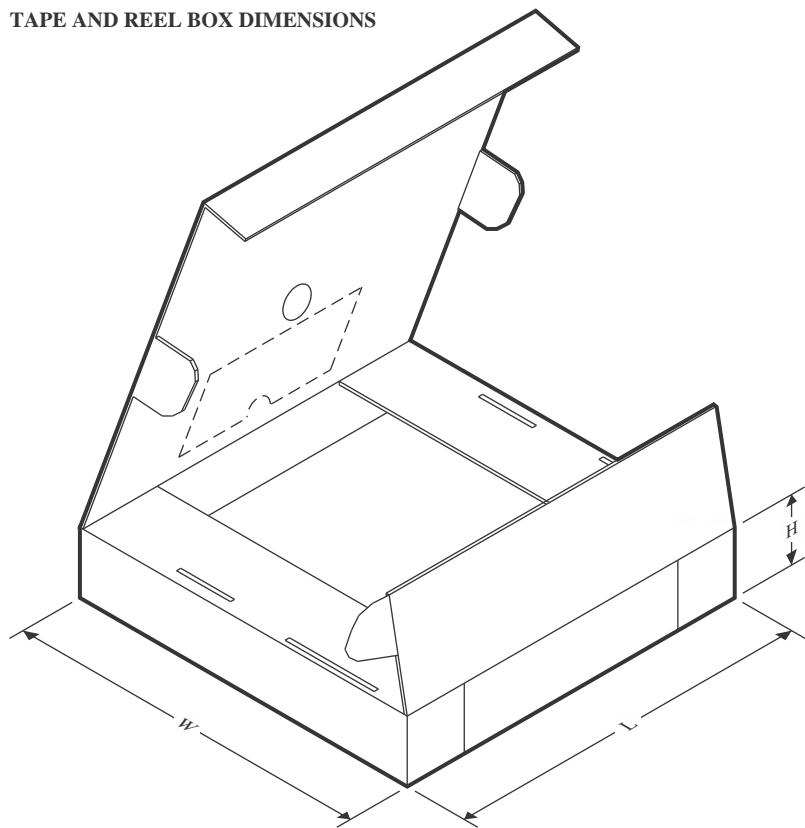
TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AUP1T08DCKR	SC70	DCK	5	3000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3
SN74AUP1T08DCKRG4	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AUP1T08DCKR	SC70	DCK	5	3000	208.0	191.0	35.0
SN74AUP1T08DCKRG4	SC70	DCK	5	3000	180.0	180.0	18.0

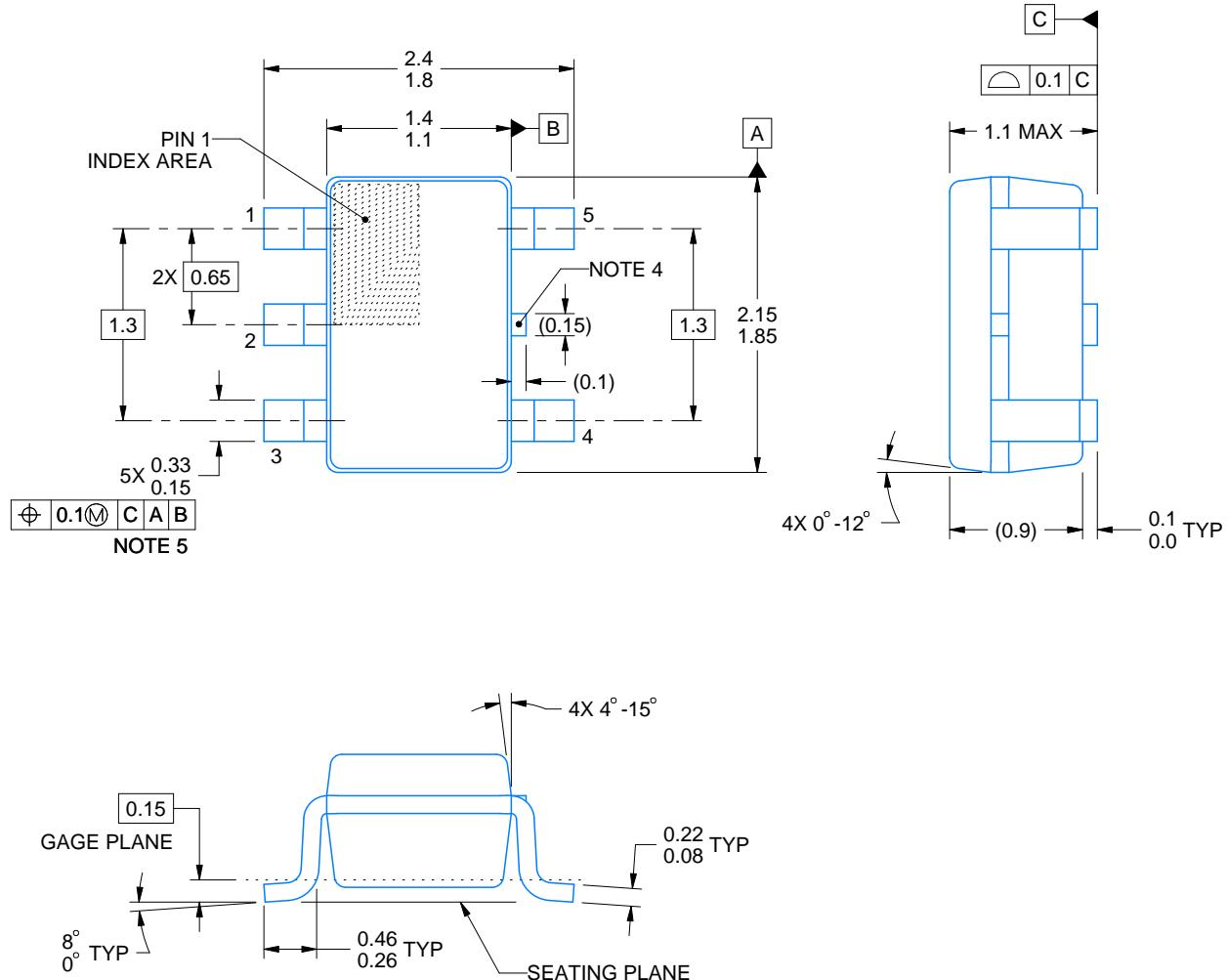
PACKAGE OUTLINE

DCK0005A



SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



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NOTES:

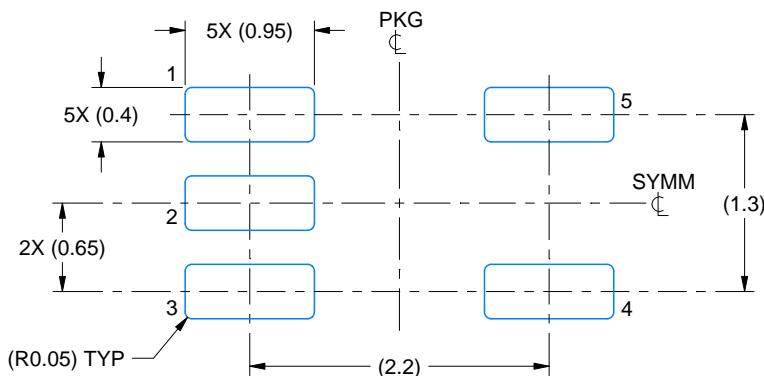
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-203.
4. Support pin may differ or may not be present.
5. Lead width does not comply with JEDEC.
6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side

EXAMPLE BOARD LAYOUT

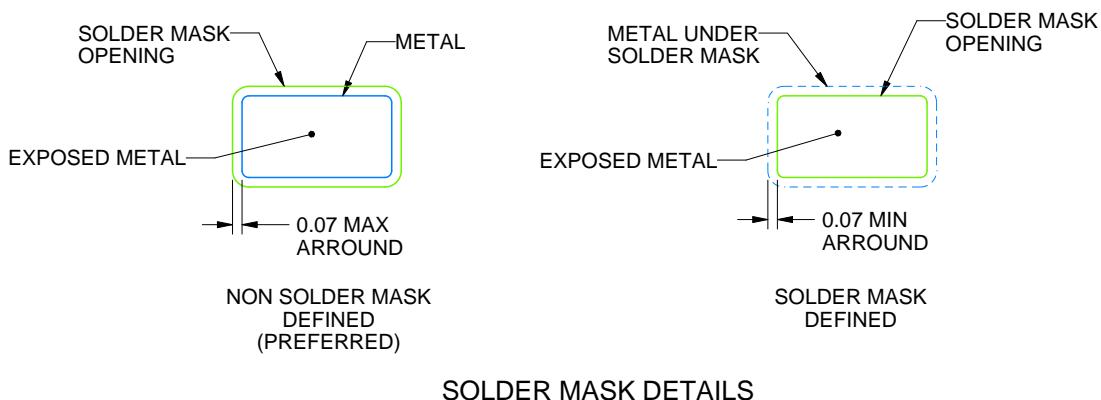
DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:18X



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NOTES: (continued)

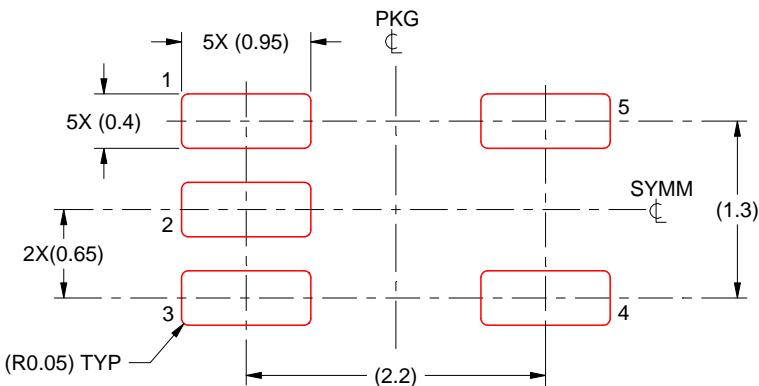
7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:18X

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NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

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